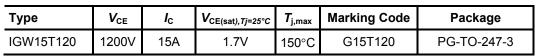


Low Loss IGBT in TrenchStop® and Fieldstop technology

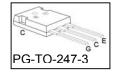
- Approx. 1.0V reduced V_{CE(sat)} compared to BUP313
- Short circuit withstand time 10µs
- Designed for:
 - Frequency Converters
 - Uninterrupted Power Supply
- TrenchStop® and Fieldstop technology for 1200 V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: http://www.infineon.com/igbt/



Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|--------------------|---------|------|
| Collector-emitter voltage | V _{CE} | 1200 | V |
| DC collector current | I _C | | Α |
| $T_{\rm C}$ = 25°C | | 30 | |
| <i>T</i> _C = 100°C | | 15 | |
| Pulsed collector current, t_p limited by T_{jmax} | I _{Cpuls} | 45 | |
| Turn off safe operating area | - | 45 | |
| $V_{CE} \le 1200 \text{V}, \ T_{j} \le 150 ^{\circ} \text{C}$ | | | |
| Gate-emitter voltage | V_{GE} | ±20 | V |
| Short circuit withstand time ²⁾ | tsc | 10 | μS |
| $V_{\rm GE}$ = 15V, $V_{\rm CC} \le$ 1200V, $T_{\rm j} \le$ 150°C | | | |
| Power dissipation | P _{tot} | 110 | W |
| $T_{\rm C}$ = 25°C | | | |
| Operating junction temperature | T _j | -40+150 | °C |
| Storage temperature | T _{stg} | -55+150 | |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s | - | 260 | |





¹ J-STD-020 and JESD-022 ²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



| Th | erma | ıl R | 20 | ietai | nce |
|----|--------|-------|------|-------|-----|
| | CIIIIC | 11 IN | . 63 | ısıa | |

| Parameter | Symbol | Conditions | Max. Value | Unit |
|--------------------------|-------------------|------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, | R _{thJC} | | 1.1 | K/W |
| junction – case | | | | |
| Thermal resistance, | R_{thJA} | | 40 | |
| junction – ambient | | | | |

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

| Parameter | Symbol Conditions - | Value | | | I I m i 4 | |
|--------------------------------------|---------------------|---|------|------|-----------|------|
| | | Conditions | min. | typ. | max. | Unit |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{\rm GE}$ =0V, $I_{\rm C}$ =0.5mA | 1200 | - | - | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{\rm GE} = 15 \rm V, I_{\rm C} = 15 \rm A$ | | | | |
| | | <i>T</i> _j =25°C | - | 1.7 | 2.2 | |
| | | T _j =125°C | - | 2.0 | - | |
| | | T _j =150°C | - | 2.2 | - | |
| Gate-emitter threshold voltage | $V_{\rm GE(th)}$ | $I_{\rm C}$ =0.6mA, $V_{\rm CE}$ = $V_{\rm GE}$ | 5.0 | 5.8 | 6.5 | |
| Zero gate voltage collector current | I _{CES} | V _{CE} =1200V, V _{GE} =0V | | | | mA |
| | | <i>T</i> _j =25°C | - | - | 0.2 | |
| | | T _j =150°C | - | - | 2.0 | |
| Gate-emitter leakage current | I _{GES} | $V_{CE} = 0V, V_{GE} = 20V$ | - | - | 100 | nA |
| Transconductance | g_{fs} | V _{CE} =20V, I _C =15A | - | 10 | - | S |
| Integrated gate resistor | R _{Gint} | | | none | | Ω |

Dynamic Characteristic

| Dynamic Characterione | | | | | | |
|---|-------------------|---|---|------|---|----|
| Input capacitance | Ciss | V _{CE} =25V, | - | 1100 | - | pF |
| Output capacitance | Coss | V _{GE} =0V, | - | 100 | - | |
| Reverse transfer capacitance | Crss | f=1MHz | - | 50 | - | |
| Gate charge | Q _{Gate} | $V_{\rm CC}$ =960V, $I_{\rm C}$ =15A | - | 85 | - | nC |
| | | V _{GE} =15V | | | | |
| Internal emitter inductance | LE | | - | 13 | - | nH |
| measured 5mm (0.197 in.) from case | | | | | | |
| Short circuit collector current ¹⁾ | $I_{C(SC)}$ | $V_{\text{GE}}=15\text{V}, t_{\text{SC}}\leq 10\mu\text{s}$ | - | 90 | - | Α |
| | | $V_{\rm CC} = 600 \rm V$ | | | | |
| | | $T_{\rm j} = 25^{\circ}{\rm C}$ | | | | |

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at T_i =25 °C

| Parameter | Cumbal | Symbol Conditions — | Value | | | Unit |
|------------------------|------------------|--|-------|------|------|-------|
| | Symbol | | min. | typ. | max. | Julii |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | T _j =25°C, | - | 50 | - | ns |
| Rise time | t _r | $V_{CC} = 600 \text{V}, I_C = 15 \text{A},$ | - | 30 | - | |
| Turn-off delay time | $t_{d(off)}$ | $V_{\rm GE}$ =0/15V, $R_{\rm G}$ =56 Ω , $L_{\sigma}^{2)}$ =180nH, $C_{\sigma}^{2)}$ =39pF Energy losses include "tail" and diode reverse recovery. | - | 520 | - | |
| Fall time | t _f | | - | 60 | - | |
| Turn-on energy | Eon | | - | 1.3 | - | mJ |
| Turn-off energy | E _{off} | | - | 1.4 | - | |
| Total switching energy | Ets | | - | 2.7 | - | |

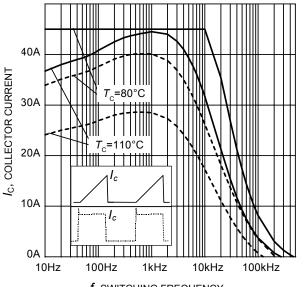
Switching Characteristic, Inductive Load, at T_i =150 °C

| Parameter | Symbol | Symbol Conditions — | Value | | | Unit |
|------------------------|----------------------|---|-------|------|------|------|
| | Syllibol | | min. | typ. | max. | |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | T _j =150°C, | - | 50 | - | ns |
| Rise time | t _r | $V_{CC} = 600 \text{V}, I_C = 15 \text{A},$ | - | 35 | - | |
| Turn-off delay time | $t_{	exttt{d(off)}}$ | $V_{\rm GE}$ =0/15V, $R_{\rm G}$ = 56 Ω | - | 600 | - | |
| Fall time | t _f | $L_{\sigma}^{(2)} = 180 \text{nH},$ | - | 120 | - | |
| Turn-on energy | Eon | $C_{\sigma}^{(2)}$ =39pF | - | 2.0 | - | mJ |
| Turn-off energy | E _{off} | Energy losses include "tail" and diode | - | 2.1 | - | |
| Total switching energy | E _{ts} | reverse recovery. | - | 4.1 | - | |

Power Semiconductors

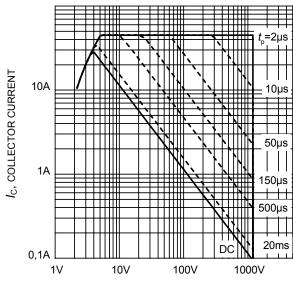
 $^{^{2)}}$ Leakage inductance L_{σ} and Stray capacity \textit{C}_{σ} due to dynamic test circuit in Figure E.





f, SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency $(T_{\rm j} \le 150^{\circ}{\rm C}, \, D=0.5, \, V_{\rm CE}=600{\rm V}, \, V_{\rm GE}=0/+15{\rm V}, \, R_{\rm G}=56\Omega)$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}\text{C}, T_i \le 150^{\circ}\text{C}; V_{GE} = 15\text{V})$

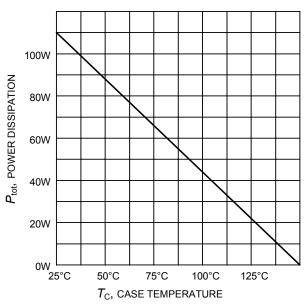


Figure 3. Power dissipation as a function of case temperature $(T_i \le 150^{\circ}\text{C})$

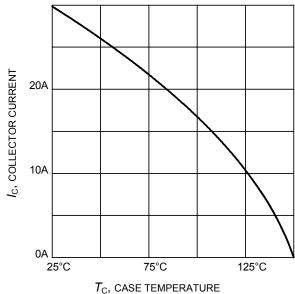


Figure 4. Collector current as a function of case temperature $(V_{GE} \ge 15V, T_i \le 150^{\circ}C)$



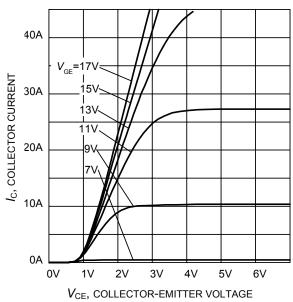


Figure 5. Typical output characteristic $(T_i = 25^{\circ}\text{C})$

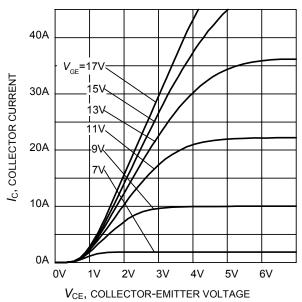


Figure 6. Typical output characteristic $(T_i = 150^{\circ}\text{C})$

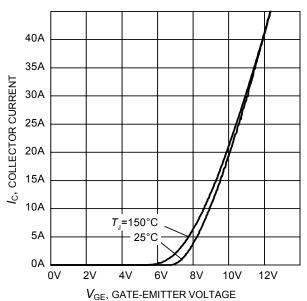


Figure 7. Typical transfer characteristic $(V_{CE}=20V)$

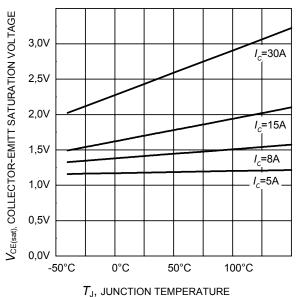


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature $(V_{GE} = 15V)$



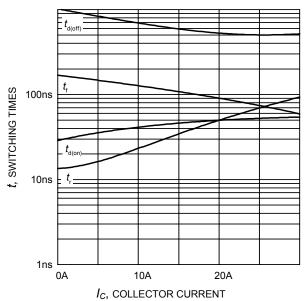


Figure 9. Typical switching times as a function of collector current (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, R_G =56 Ω , Dynamic test circuit in Figure E)

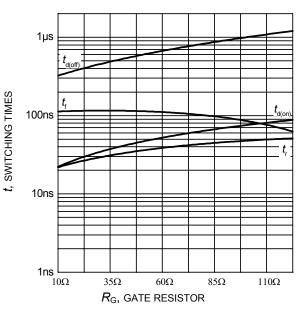


Figure 10. Typical switching times as a function of gate resistor (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, I_{C} =15A, Dynamic test circuit in Figure E)

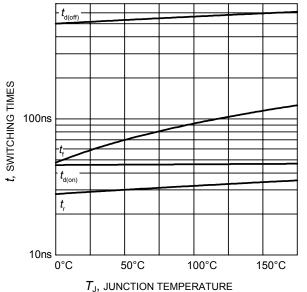


Figure 11. Typical switching times as a function of junction temperature (inductive load, V_{CE} =600V, V_{GE} =0/15V, I_{C} =15A, R_{G} =56 Ω , Dynamic test circuit in Figure E)

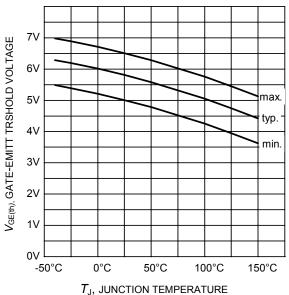


Figure 12. Gate-emitter threshold voltage as a function of junction temperature $(I_C = 0.6 \text{mA})$



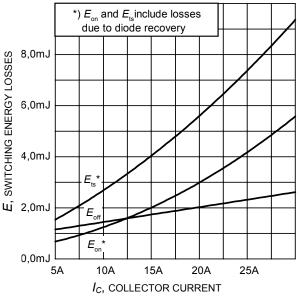


Figure 13. Typical switching energy losses as a function of collector current (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, R_G =56 Ω , Dynamic test circuit in Figure E)

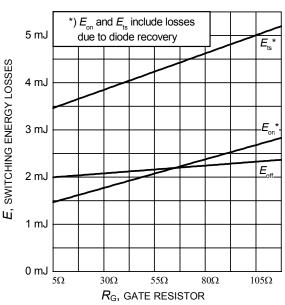


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, I_C =15A, Dynamic test circuit in Figure E)

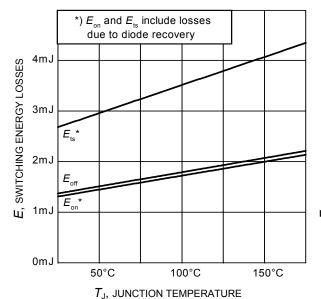
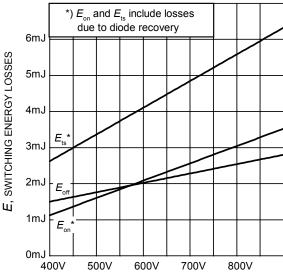


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, V_{CE}=600V,

(inductive load, $V_{\rm CE}$ =600V, $V_{\rm GE}$ =0/15V, $I_{\rm C}$ =15A, $R_{\rm G}$ =56 Ω , Dynamic test circuit in Figure E)



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load, T_J =150°C, V_{GE} =0/15V, I_C =15A, R_G =56 Ω , Dynamic test circuit in Figure E)





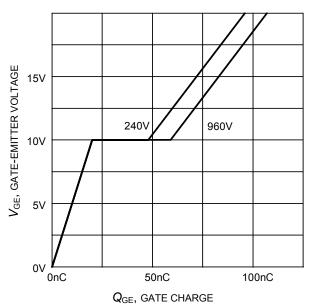
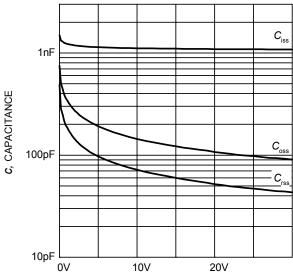


Figure 17. Typical gate charge $(I_C=15 \text{ A})$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f=1 \text{ MHz})$

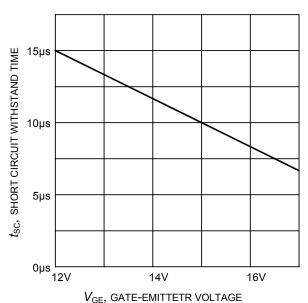
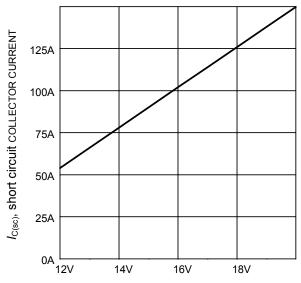


Figure 19. Short circuit withstand time as a function of gate-emitter voltage (V_{CE} =600V, start at T_J =25°C)



 $V_{\rm GE}$, GATE-EMITTETR VOLTAGE

Figure 20. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 600\text{V}, T_i \le 150^{\circ}\text{C})$



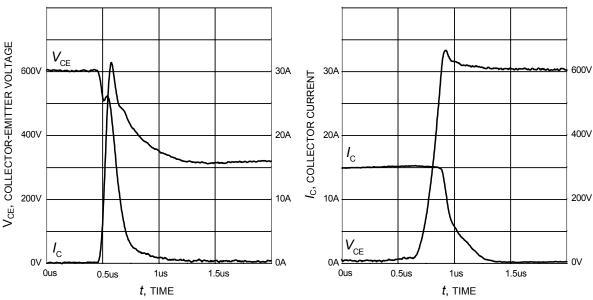


Figure 21. Typical turn on behavior $(V_{GE}=0/15V, R_{G}=56\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$

Figure 22. Typical turn off behavior $(V_{GE}=15/0V, R_{G}=56\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$

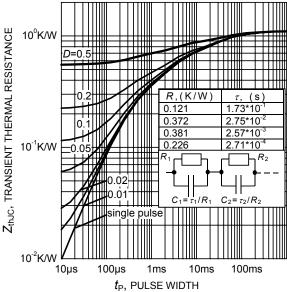
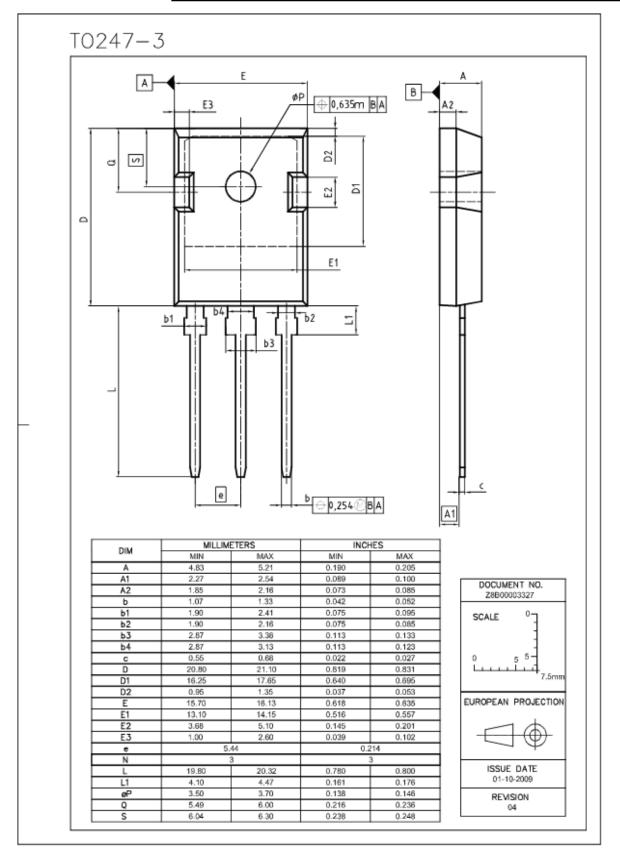


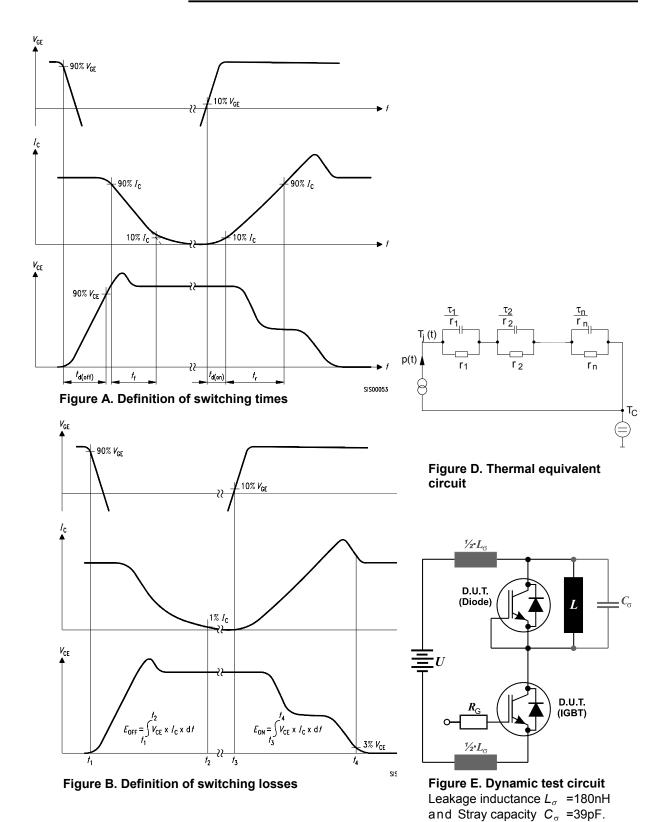
Figure 23. IGBT transient thermal resistance $(D = t_p / T)$











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